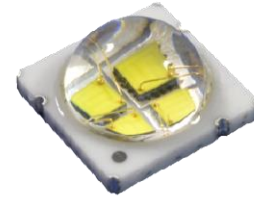


Gallery White LED Emitter

LZ4-00GW08



Key Features

- 4-die Gallery White (CRI 98) LED
- 3 SDCM color bins for 3 CCTs - 2700K, 2850K, 3000K
- Superior Color Rendering: CRI (Ra) 98; R9 98 and R15 98
- Up to 10 Watt power dissipation on compact 7.0mm x 7.0mm footprint
- Low Thermal Resistance (2.8°C/W)
- Engineered ceramic package with integrated glass lens
- JEDEC Level 1 for Moisture Sensitivity Level
- Autoclave compliant (JEDEC JESD22-A102-C)
- Lead (Pb) free and RoHS compliant
- Reflow solderable (up to 6 cycles)
- Emitter available on Standard or Serially connected MCPCB (optional)
- Full suite of TIR secondary optics family available

Typical Applications

- Gallery lighting
- Museum lighting
- High-end retail lighting
- Medical surgery lighting

Description

The LZ4-00GW08 Gallery White features warm white light with an exceptional color rendering index (CRI) of 98, as well as impressive individual R values (R1-16) in industry's smallest footprint. It enables accurate color representation and enhances the contrast of retail merchandise, artwork and skin tones, which cannot be obtained with standard warm white LED emitters. The emitter, based on LED Engin's LuxiGen technology platform, may be driven up to 10W of power in a compact 7.0mmx7.0mm footprint. It has the industry lowest thermal resistance per package size, which allows users to drive the emitter with higher current, while keeping the junction temperature low to ensure long operating life.

Part number options

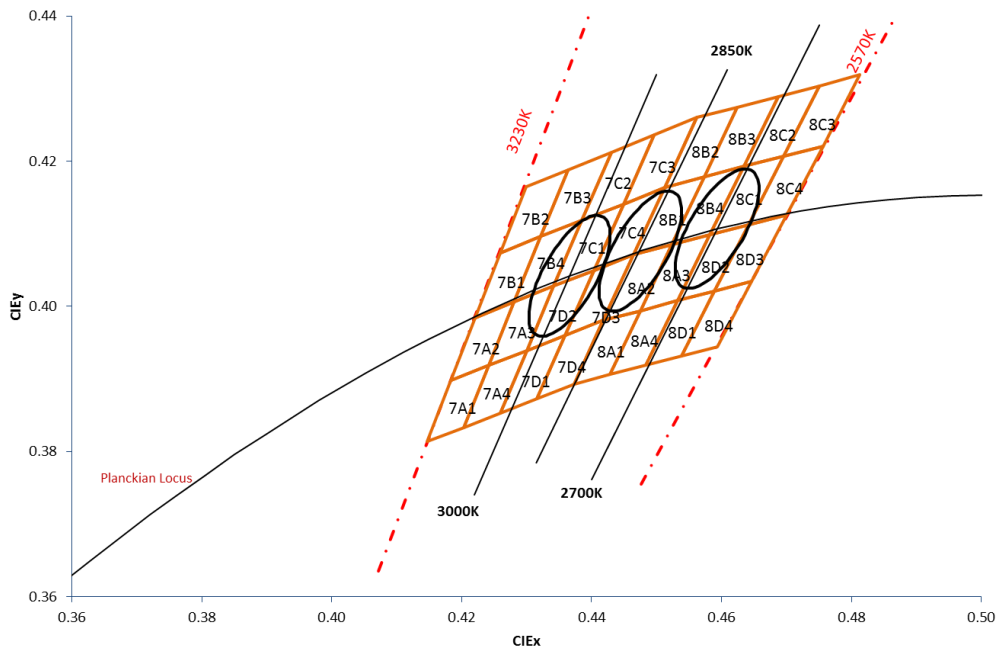
Base part number

Part number	Description
LZ4-00GW08-xxxx	LZ4 Gallery White emitter
LZ4-40GW08-xxxx	LZ4 Gallery White emitter on Standard Star 1 channel MCPCB

Bin kit option codes

GW, Gallery White (CRI 98)			
Kit number suffix	Min flux Bin	Chromaticity bins	Description
0027	S	3-step MacAdams ellipse	full distribution flux; 2700K ANSI CCT
0028	S	3-step MacAdams ellipse	full distribution flux; 2850K ANSI CCT
0030	S	3-step MacAdams ellipse	full distribution flux; 3000K ANSI CCT

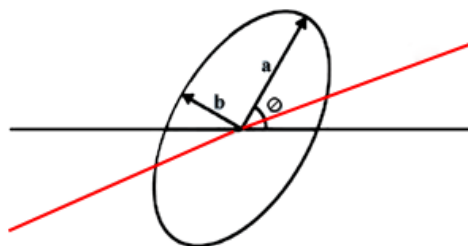
Gallery White CCT Bins



3-step MacAdam ellipse color bins plotted on excerpt from the CIE 1931 (2°) x-y Chromaticity Diagram. Coordinates are listed below in the table.

Gallery White 3-Step MacAdam Ellipse CCT Bin Coordinates

Nominal ANSI CCT	Center Point (cx, cy)	Major Axis a	Minor Axis b	Ellipse Rotation Angle (°)
2700	(0.4593, 0.4107)	0.00966	0.00403	55.2
2850	(0.4475, 0.4076)	0.00968	0.00403	55.9
3000	(0.4366, 0.4042)	0.00967	0.00399	56.6



Luminous Flux Bins

Table 1:

Bin Code	Minimum Luminous Flux (Φ_v) @ $I_F = 700\text{mA}$ ^[1,2] (lm)	Maximum Luminous Flux (Φ_v) @ $I_F = 700\text{mA}$ ^[1,2] (lm)	Typical Luminous Flux (Φ_v) @ $I_F = 1000\text{mA}$ ^[2] (lm)
S	356	445	810
T	445	556	650

Notes for Table 1:

1. Luminous flux performance guaranteed within published operating conditions. LED Engin maintains a tolerance of $\pm 10\%$ on flux measurements.

Forward Voltage Bin

Table 2:

Bin Code	Minimum Forward Voltage (V_F) @ $I_F = 700\text{mA}$ ^[1,2] (V)	Maximum Forward Voltage (V_F) @ $I_F = 700\text{mA}$ ^[1,2] (V)
0	12.0	14.4

Notes for Table 2:

1. Forward Voltage is binned with all four LED dice connected in series.
2. LED Engin maintains a tolerance of $\pm 0.4\text{V}$ for forward voltage measurements for the four LEDs.

Color Rendering Index Bin

Table 3:

Bin Code	Minimum Color Rendering Index @ $I_F = 700\text{mA}$
0	95.0

Absolute Maximum Ratings

Table 4:

Parameter	Symbol	Value	Unit
DC Forward Current ^[1]	I _F	1000	mA
Peak Pulsed Forward Current ^[2]	I _{FP}	2000	mA
Reverse Voltage	V _R	See Note 3	V
Storage Temperature	T _{stg}	-40 ~ +150	°C
Junction Temperature	T _J	150	°C
Soldering Temperature ^[4]	T _{sol}	260	°C
Allowable Reflow Cycles		6	
Autoclave Conditions ^[5]		121°C at 2 ATM, 100% RH for 168 hours	
ESD Sensitivity ^[6]		> 8,000 V HBM Class 3B JESD22-A114-D	

Notes for Table 4:

- Maximum DC forward current (per die) is determined by the overall thermal resistance and ambient temperature. Follow the curves in Figure 10 for current derating.
- Pulse forward current conditions: Pulse Width ≤ 10msec and Duty cycle ≤ 10%.
- LEDs are not designed to be reverse biased.
- Solder conditions per JEDEC 020D. See Reflow Soldering Profile Figure 5.
- Autoclave Conditions per JEDEC JESD22-A102-C.
- LED Engin recommends taking reasonable precautions towards possible ESD damages and handling the LZ4-00GW08 in an electrostatic protected area (EPA). An EPA may be adequately protected by ESD controls as outlined in ANSI/ESD S6.1.

Optical Characteristics @ T_C = 25°C

Table 5:

Parameter	Symbol	Typical	Unit
Luminous Flux (@ I _F = 700mA) ^[1]	Φ _V	480	lm
Luminous Flux (@ I _F = 1000mA) ^[1]	Φ _V	620	lm
Luminous Efficacy (@ I _F = 350mA)		67	lm/W
Correlated Color Temperature	CCT	3000	K
Color Rendering Index (CRI) ^[2]	R _a	98	
Viewing Angle ^[3]	2Θ _{1/2}	105	Degrees
Total Included Angle ^[4]	Θ _{0.9V}	135	Degrees

Notes for Table 5:

- Luminous flux typical value is for all four LED dice operating concurrently at rated current.
- Typical R_a and individual R1 through R16 values listed in Table 6
- Viewing Angle is the off axis angle from emitter centerline where the luminous intensity is ½ of the peak value.
- Total Included Angle is the total angle that includes 90% of the total luminous flux.

Typical CRI (Ra) and individual R values

Table 6:

Ra	R1	R2	R3	R4	R5	R6	R7	R8	R9	R10	R11	R12	R13	R14	R15	R16
98	98	99	97	98	98	98	98	98	98	99	96	86	98	97	98	96

Electrical Characteristics @ $T_C = 25^\circ\text{C}$

Table 7:

Parameter	Symbol	Typical	Unit
Forward Voltage (@ $I_F = 700\text{mA}$) ^[1]	V_F	12.9	V
Forward Voltage (@ $I_F = 1000\text{mA}$) ^[1]	V_F	13.3	V
Temperature Coefficient of Forward Voltage ^[1]	$\Delta V_F / \Delta T_J$	-8.0	mV/ $^\circ\text{C}$
Thermal Resistance (Junction to Case)	$R\Theta_{J-C}$	2.8	$^\circ\text{C/W}$

Notes for Table 7:

1. Forward Voltage typical value is for all four LED dice connected in series.

IPC/JEDEC Moisture Sensitivity Level

Table 8 - IPC/JEDEC J-STD-20D.1 MSL Classification:

Soak Requirements						
Floor Life			Standard		Accelerated	
Level	Time	Conditions	Time (hrs)	Conditions	Time (hrs)	Conditions
1	Unlimited	$\leq 30^\circ\text{C}/$ 85% RH	168 +5/-0	$85^\circ\text{C}/$ 85% RH	n/a	n/a

Notes for Table 8:

1. The standard soak time includes a default value of 24 hours for semiconductor manufacturer's exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor's facility.

Average Lumen Maintenance Projections

Lumen maintenance generally describes the ability of a lamp to retain its output over time. The useful lifetime for solid state lighting devices (Power LEDs) is also defined as Lumen Maintenance, with the percentage of the original light output remaining at a defined time period.

Based on long-term WHTOL testing, LED Engin projects that the LZ4 Series will deliver, on average, 90% Lumen Maintenance at 65,000 hours of operation at a forward current of 700 mA per die. This projection is based on constant current operation with junction temperature maintained at or below 110°C .

Recommended 8mil Stencil Apertures Layout (mm)

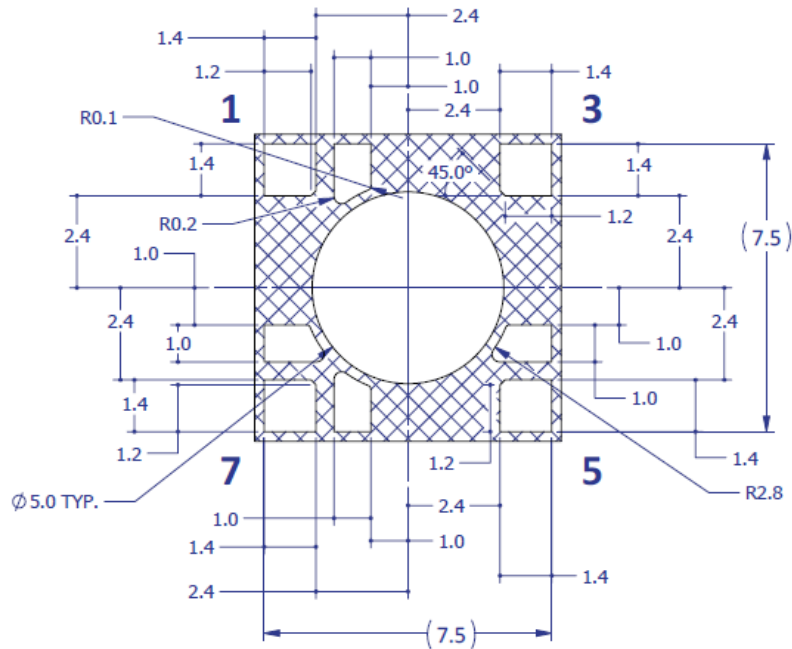


Figure 2b: Recommended solder mask opening (hatched area) for anode, cathode, and thermal pad.

Note for Figure 2b:

1. Unless otherwise noted, the tolerance = ± 0.20 mm.

Reflow Soldering Profile

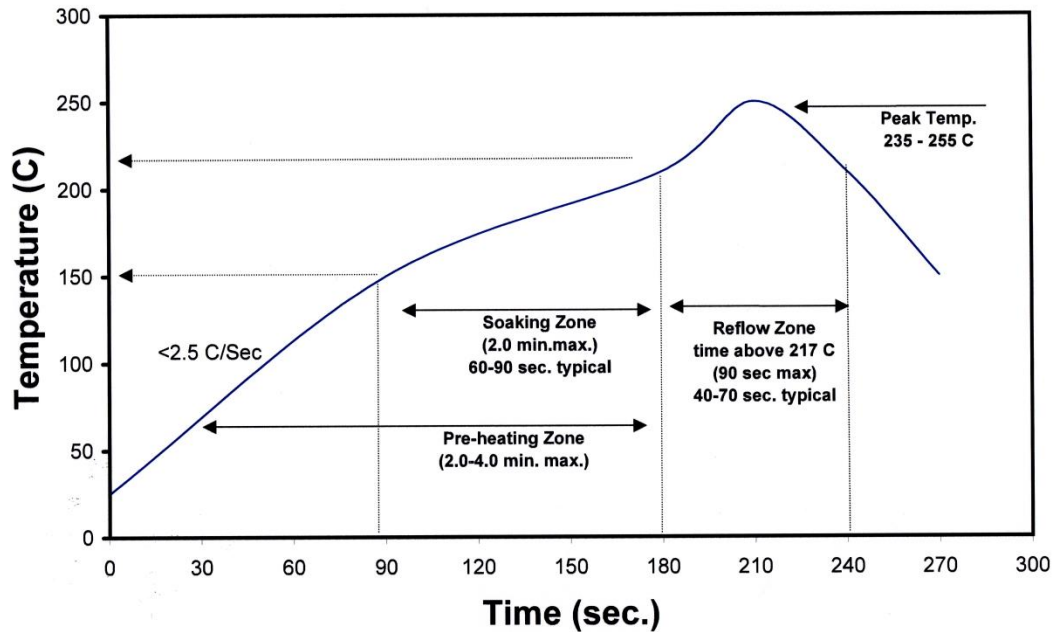


Figure 3: Reflow soldering profile for lead free soldering.

Typical Radiation Pattern

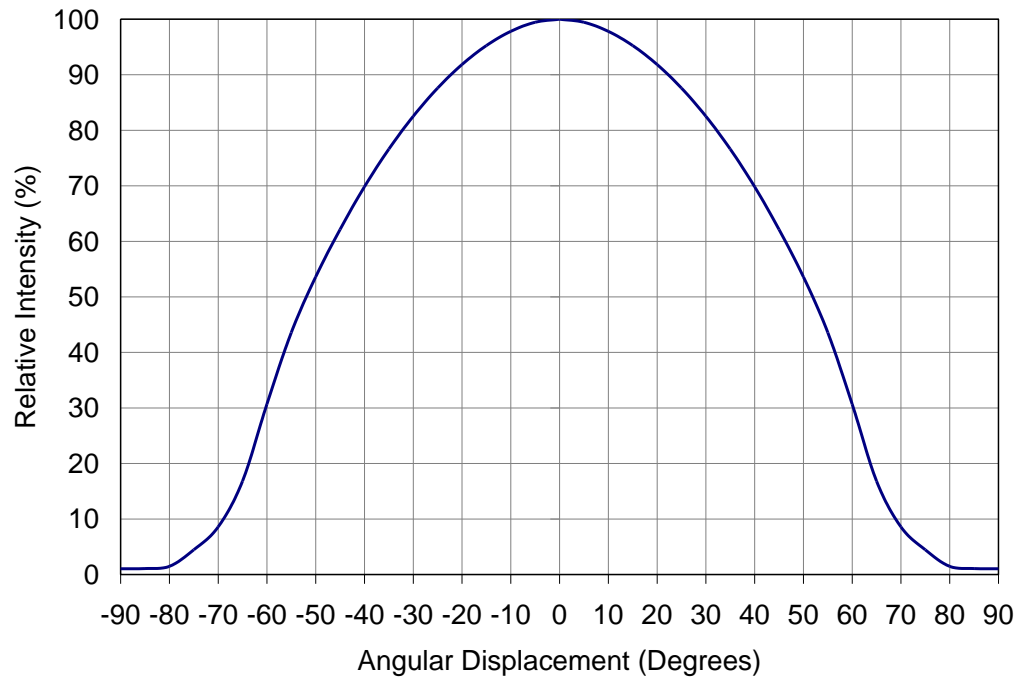


Figure 4: Typical representative spatial radiation pattern.

Typical Relative Spectral Power Distribution

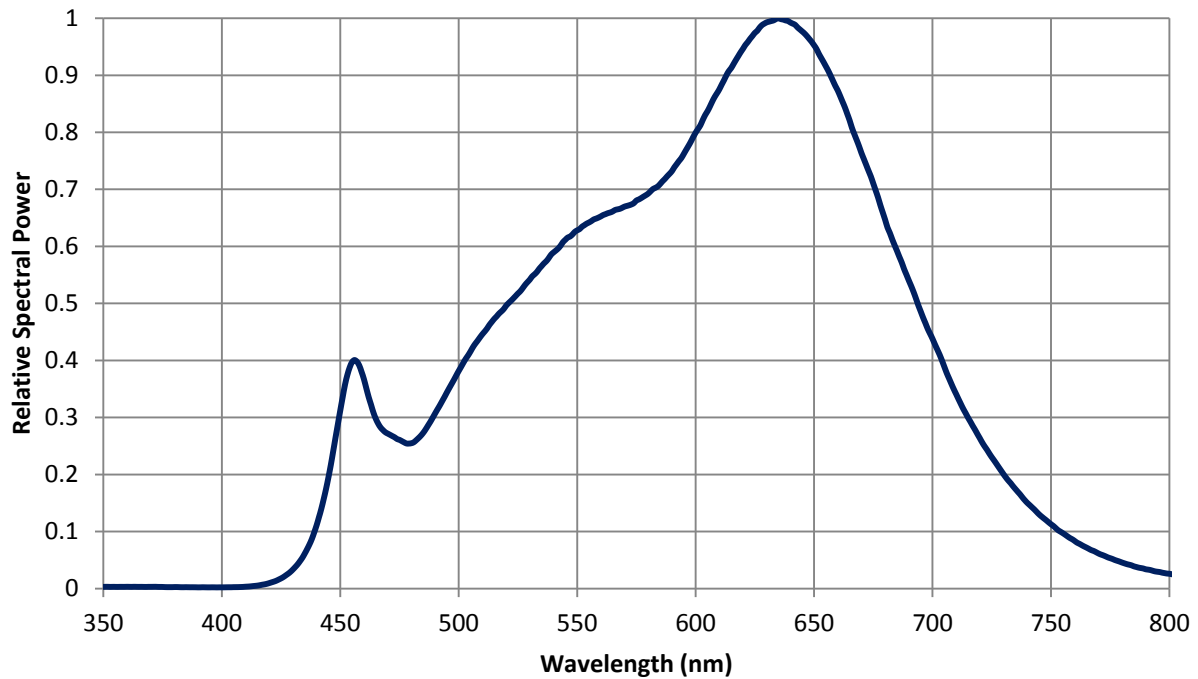


Figure 5: Typical relative spectral power vs. wavelength @ T_c = 25°C.

Typical Relative Light Output over Forward Current

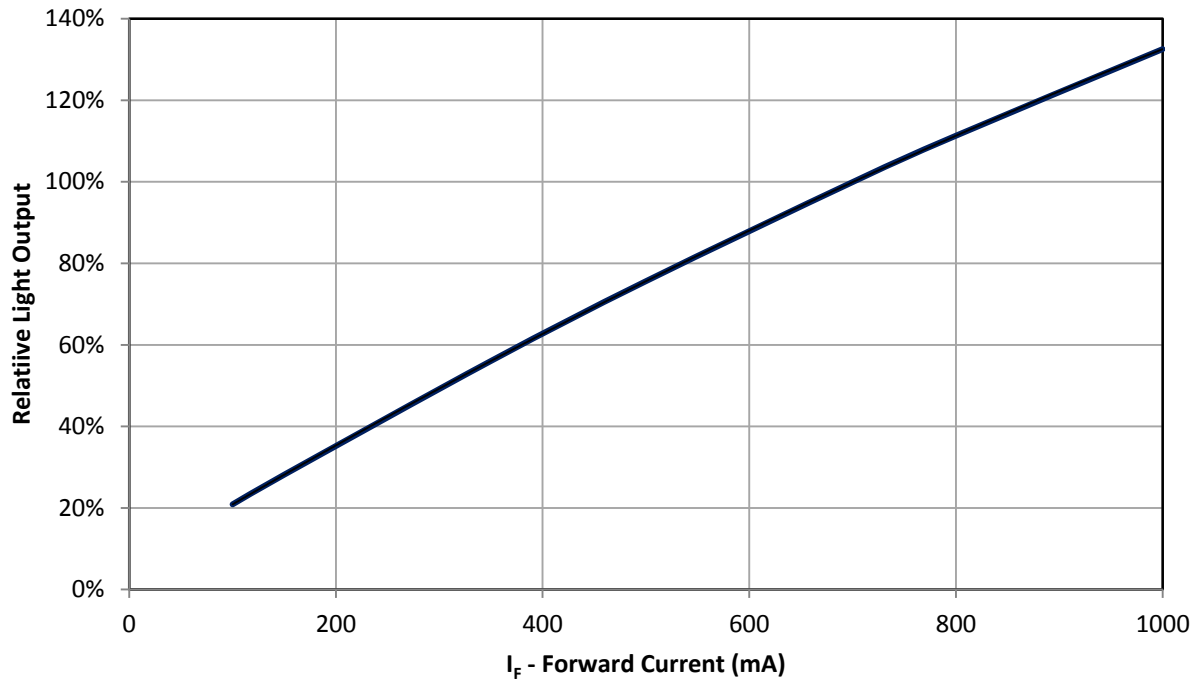


Figure 6: Typical relative light output vs. forward current @ $T_C = 25^\circ\text{C}$.

Typical Relative Light Output over Temperature

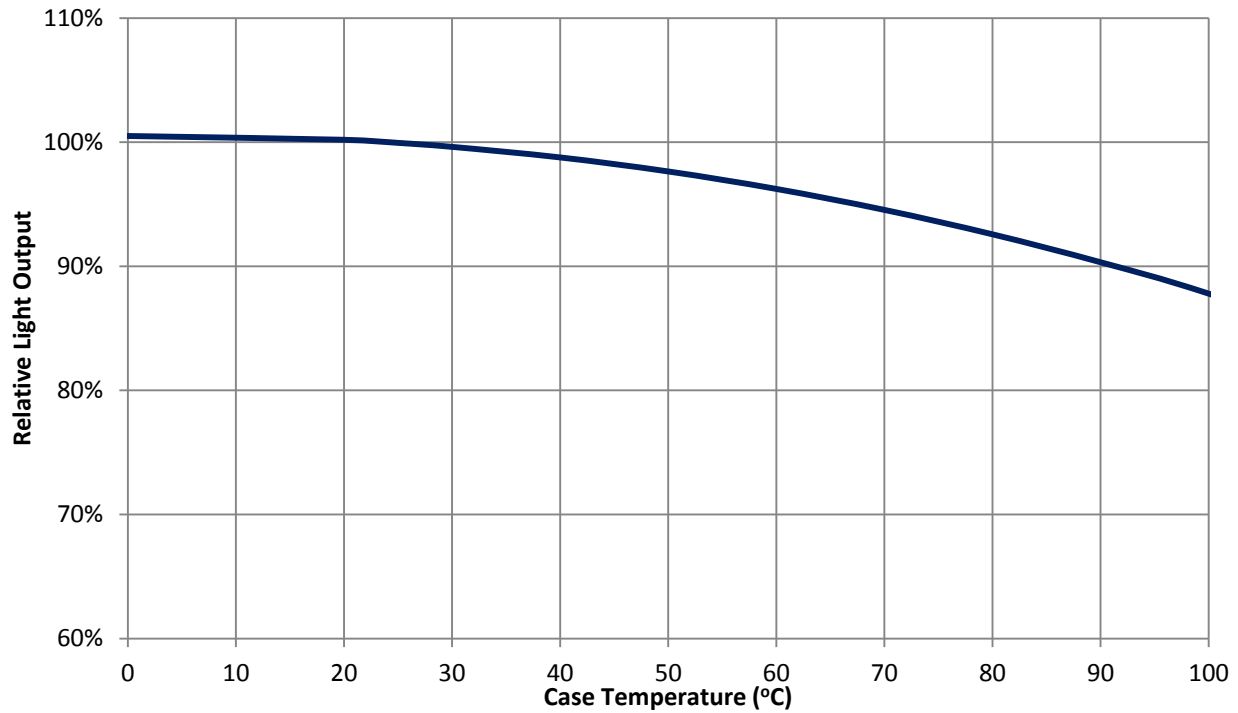


Figure 7: Typical relative light output vs. case temperature.

Typical Chromaticity Coordinate Shift over Forward Current

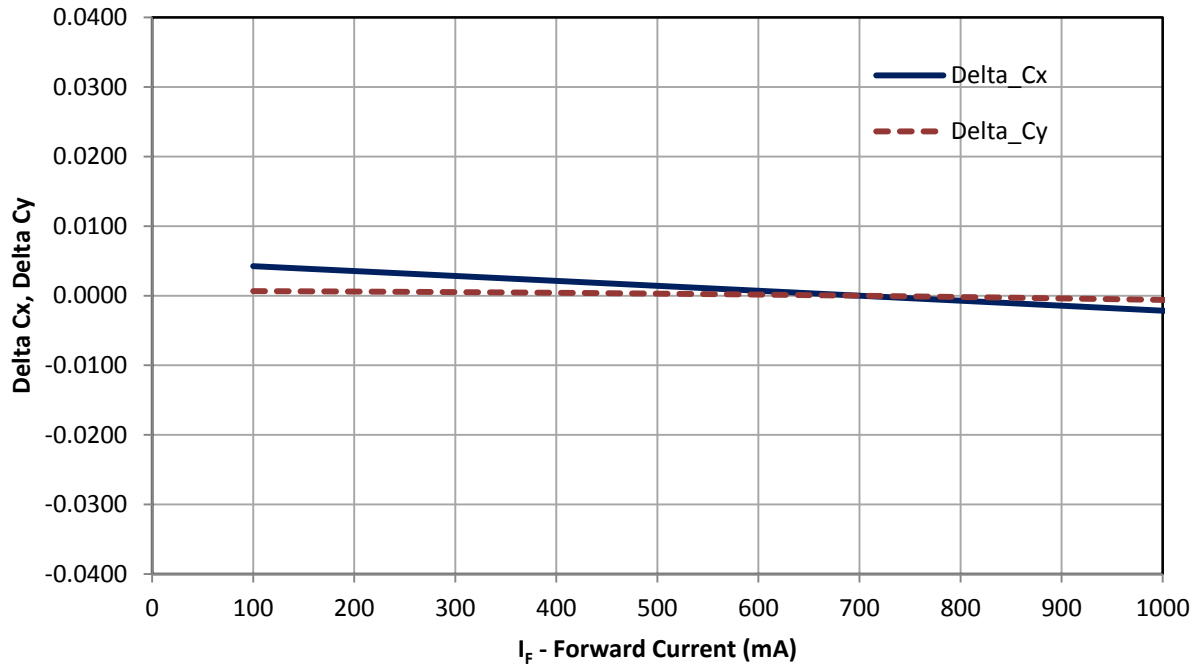


Figure 8: Typical chromaticity coordinate shift vs. forward current

Typical Chromaticity Coordinate Shift over Temperature

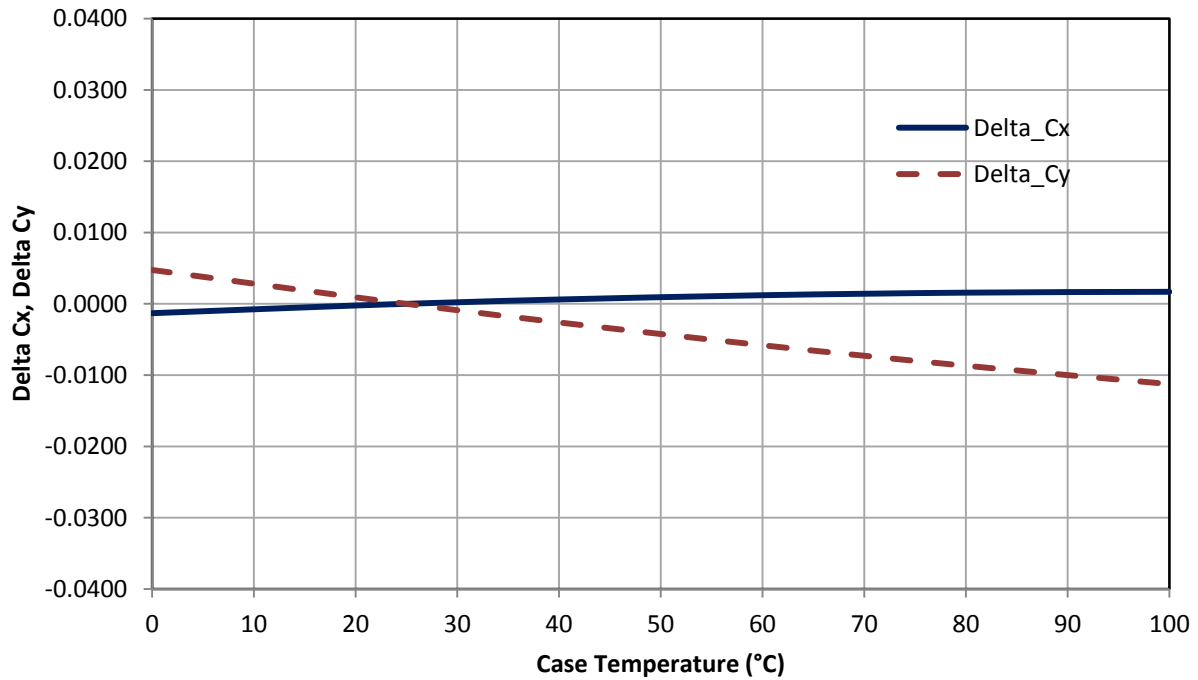


Figure 9: Typical chromaticity coordinate shift vs. Case temperature

Typical Forward Current Characteristics

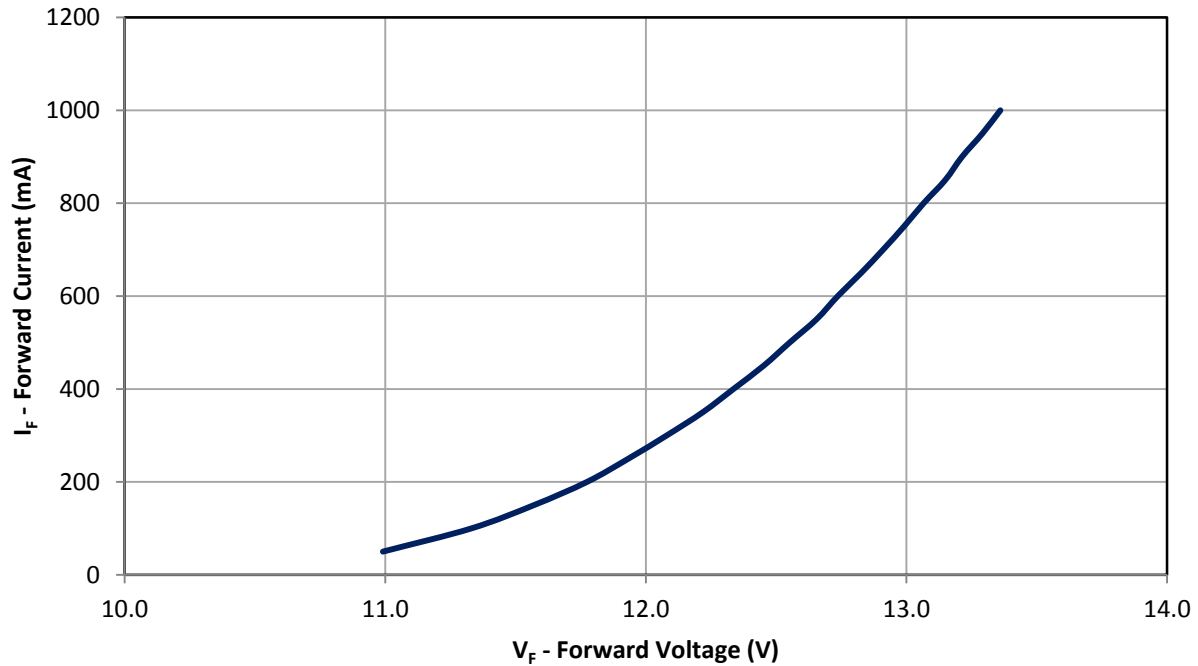


Figure 10: Typical forward current vs. forward voltage @ T_c = at 25°C.

Note for Figure 10:

1. Forward Voltage curve assumes that all four LED dice are connected in series.

Current De-rating

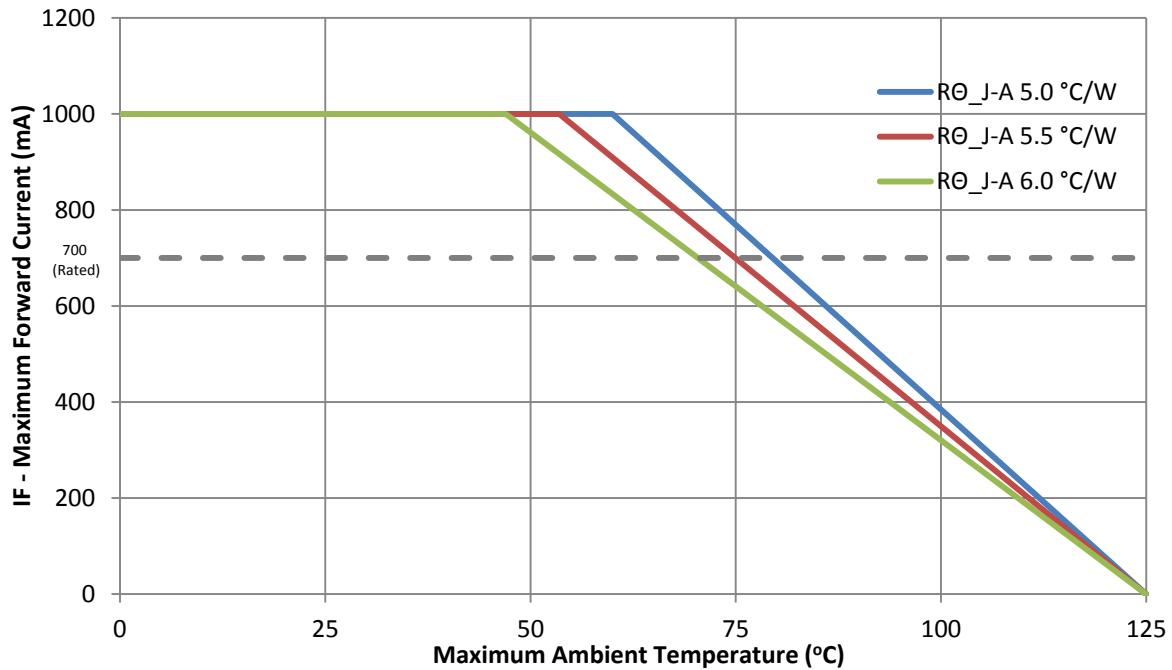


Figure 11: Maximum forward current vs. ambient temperature based on $T_{j(MAX)} = 150^{\circ}\text{C}$.

Notes for Figure 11:

1. Maximum current assumes that all four LED dice are operating concurrently at the same current.
2. $R_{\theta JC}$ [Junction to Case Thermal Resistance] for the LZ4-00GW08 is typically 2.8°C/W.
3. $R_{\theta JA}$ [Junction to Ambient Thermal Resistance] = $R_{\theta JC} + R_{\theta CA}$ [Case to Ambient Thermal Resistance].

Emitter Tape and Reel Specifications (mm)

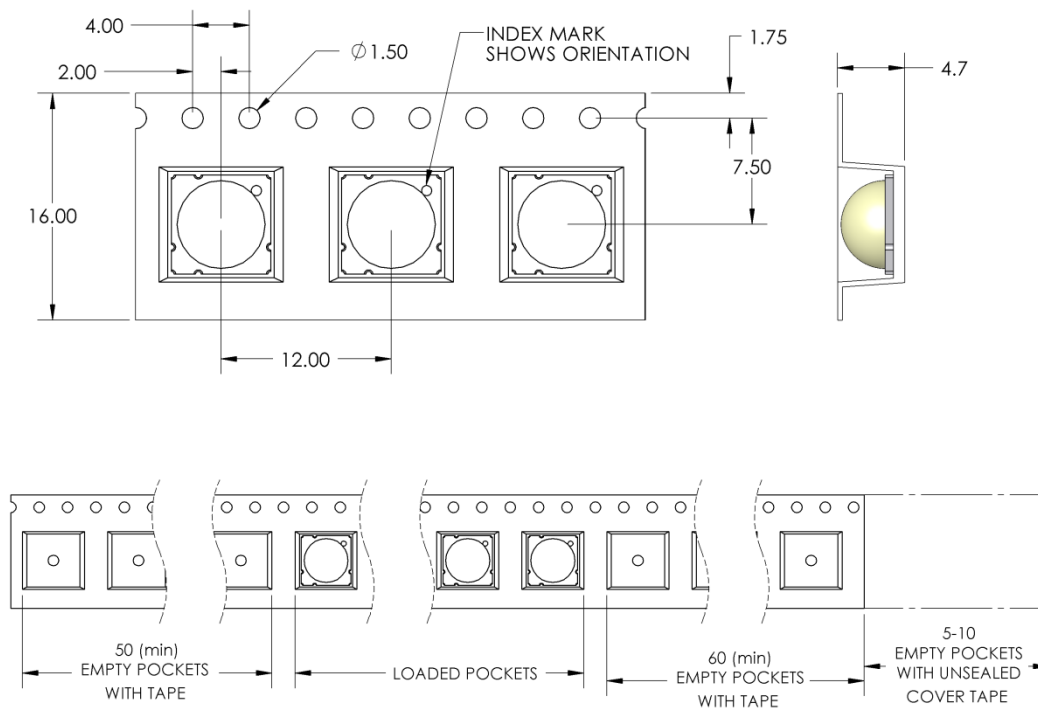


Figure 12: Emitter carrier tape specifications (mm).

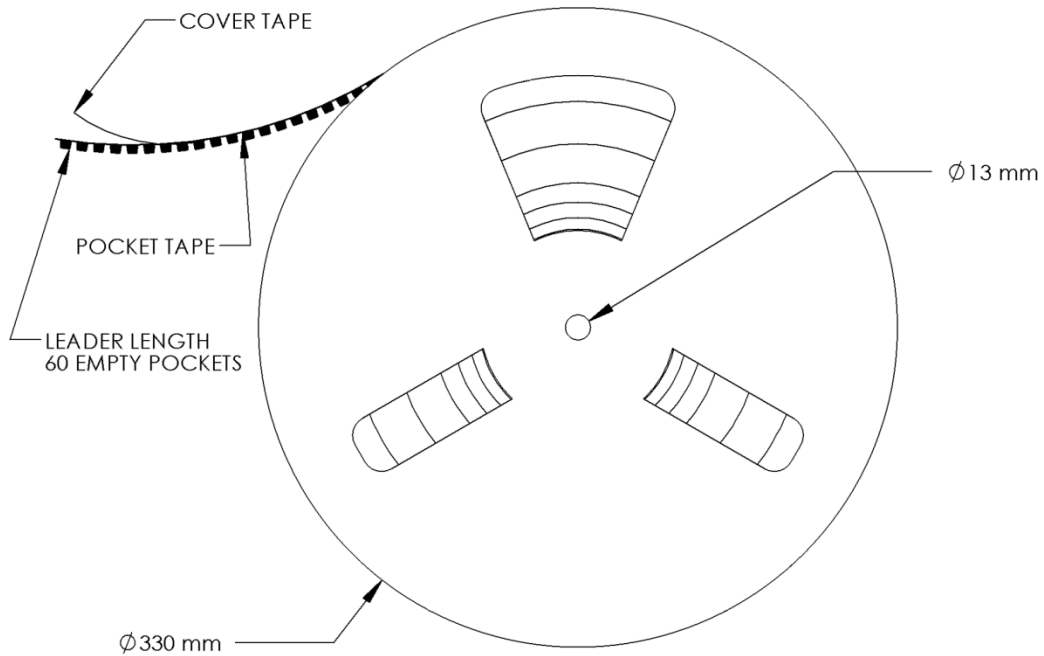


Figure 13: Emitter Reel specifications (mm).

LZ4 MCPCB Family

Part number	Type of MCPCB	Diameter (mm)	Emitter + MCPCB Thermal Resistance (°C/W)	Typical V _f (V)	Typical I _f (mA)
LZ4-4xxxxxx	1-channel	19.9	2.8 + 1.1 = 3.9	12.9	700

Mechanical Mounting of MCPCB

- MCPCB bending should be avoided as it will cause mechanical stress on the emitter, which could lead to substrate cracking and subsequently LED dies cracking.
- To avoid MCPCB bending:
 - Special attention needs to be paid to the flatness of the heat sink surface and the torque on the screws.
 - Care must be taken when securing the board to the heat sink. This can be done by tightening three M3 screws (or #4-40) in steps and not all the way through at once. Using fewer than three screws will increase the likelihood of board bending.
 - It is recommended to always use plastics washers in combinations with the three screws.
 - If non-taped holes are used with self-tapping screws, it is advised to back out the screws slightly after tightening (with controlled torque) and then re-tighten the screws again.

Thermal interface material

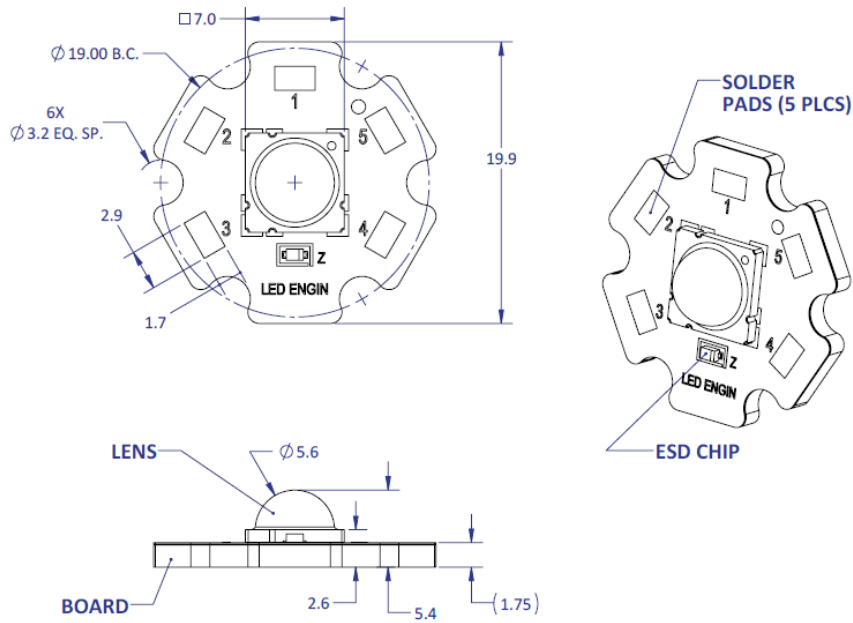
- To properly transfer heat from LED emitter to heat sink, a thermally conductive material is required when mounting the MCPCB on to the heat sink.
- There are several varieties of such material: thermal paste, thermal pads, phase change materials and thermal epoxies. An example of such material is Electrolube EHTC.
- It is critical to verify the material's thermal resistance to be sufficient for the selected emitter and its operating conditions.

Wire soldering

- To ease soldering wire to MCPCB process, it is advised to preheat the MCPCB on a hot plate of 125-150°C. Subsequently, apply the solder and additional heat from the solder iron will initiate a good solder reflow. It is recommended to use a solder iron of more than 60W.
- It is advised to use lead-free, no-clean solder. For example: SN-96.5 AG-3.0 CU 0.5 #58/275 from Kester (pn: 24-7068-7601)

LZ4-4xxxxx

1 channel, Standard Star MCPCB (1x4) Dimensions (mm)



Notes:

- Unless otherwise noted, the tolerance = ± 0.2 mm.
- Slots in MCPCB are for M3 or #4-40 mounting screws.
- LED Engin recommends plastic washers to electrically insulate screws from solder pads and electrical traces.
- LED Engin recommends thermal interface material when attaching the MCPCB to a heatsink
- The thermal resistance of the MCPCB is: $R_{\theta C-B}$ 1.1°C/W

Components used

MCPCB: HT04503 (Bergquist)
ESD chips: BZX585-C30 (NPX, for 4 LED dies in series)

Pad layout			
Ch.	MCPCB Pad	String/die	Function
1	1,2,3	1/ABCD	Cathode -
	4,5		Anode +

Company Information

LED Engin, based in California's Silicon Valley, develops, manufactures, and sells advanced LED emitters, optics and light engines to create uncompromised lighting experiences for a wide range of entertainment, architectural, general lighting and specialty applications. LuxiGen™ multi-die emitter and secondary lens combinations reliably deliver industry-leading flux density, upwards of 5000 quality lumens to a target, in a wide spectrum of colors including whites, tunable whites, multi-color and UV LEDs in a unique patented compact ceramic package. Our LuxiTune™ series of tunable white lighting modules leverage our LuxiGen emitters and lenses to deliver quality, control, freedom and high density tunable white light solutions for a broad range of new recessed and downlighting applications. The small size, yet remarkably powerful beam output and superior in-source color mixing, allows for a previously unobtainable freedom of design wherever high-flux density, directional light is required.

LED Engin is committed to providing products that conserve natural resources and reduce greenhouse emissions.

LED Engin reserves the right to make changes to improve performance without notice.

Please contact sales@ledengin.com or (408) 922-7200 for more information.

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